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Invention: CHEMICAL	LY AMPLIFIED POSITIVE PH	OTOSENSITIVE RESIN COMPOS	SITION
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## (54) RADIATION SENSITIVE RESIN COMPOSITION AND METHOD FOR PRODUCING PLATED/SHAPED BODY

## (57)Abstract:

PROBLEM TO BE SOLVED: To provide a positive type radiation sensitive resin composition giving a pattern free of cracking even in plating and even by washing and drying after plating, capable of precisely forming a thick plated/shaped body such as a bump or wiring and excellent also in sensitivity, resolution, etc., and a method for producing the plated/shaped body using the composition.

SOLUTION: The positive type radiation sensitive resin composition contains (A) a polymer having an acid dissociable functional group which is dissociated by an acid to form an acidic functional group, (B) a poly(vinyl lower alkyl ether), (C) a component which generates the acid when irradiated and (D) an organic solvent. The composition is also used as a positive type radiation sensitive resin film. The plated/shaped body is produced through a step for carrying out electroplating using a pattern formed on a substrate from the composition or the resin film as a template.

## **LEGAL STATUS**

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